

Listing of Claims:

1-42. (Cancelled)

43. (Previously Presented) A method of passivating a multilayer conductive structure, comprising:

layering a first conductive material;
introducing said first conductive material to methylsilane;
applying electromagnetic energy to the methylsilane introduced to the first conductive material, wherein applying electromagnetic energy comprises directing ultraviolet light toward the methylsilane; and
layering a second conductive material over said first conductive material.

44-77. (Cancelled)

78. (Previously Presented) A method of passivating a multilayer conductive structure, comprising:

layering a first conductive material;
introducing the first conductive material to methylsilane;
applying electromagnetic energy to the methylsilane introduced to the first conductive material, wherein applying electromagnetic energy comprises applying ultraviolet energy at a power level ranging from approximately about 50 watts and approximately about 3000 watts; and
layering a second conductive material over the first conductive material.

79-83. (Cancelled)

84. (Previously Presented) The method in claim 78, wherein applying electromagnetic energy to the material comprises directing ultraviolet light toward the material introduced to the first conductive material.

85. (Cancelled)

86. (Previously Presented) A method of passivating a multilayer conductive structure, comprising:

layering a first conductive material;

introducing the first conductive material to methylsilane;

directing ultraviolet light toward the material introduced to the first conductive material; and

layering a second conductive material over the first conductive material.

87. (Previously Presented) The method of claim 86, wherein directing ultraviolet light further comprises applying the ultraviolet light at a power level ranging from approximately about 50 watts and approximately about 3000 watts.